

CRMKTL10150A

N-Channel 100V, 120mΩ Typ. Power MOSFET

Description

Features

• 100V, 10A

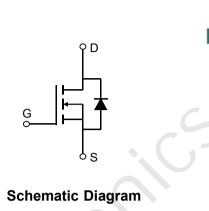
 $R_{DS(ON)}$ Typ = 120m Ω @ V_{GS} = 10V

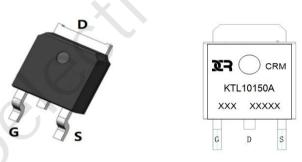
 $R_{DS(ON)}$ Typ = 126m Ω @ V_{GS} = 4.5V

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

Application

- Load Switch
- PWM Application
- Power Management





Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMKTL10150A	CRMKTL10150A	TO-252-3L	TAPING	13"	2500	25000

Absolute Maximum Ratings (@ $T_J = 25^{\circ}C$ unless otherwise specified)

Symbol	Parameter		Value	Units
V _{DS}	Drain-to-Source Voltage		100	V
V _{GS}	Gate-to-Source Voltage		±20	V
	Continuous Drain Current	T _C = 25°C	10	А
Ι _D	Continuous Drain Current	T _C = 100°C	6	А
I _{DM}	Pulsed Drain Current ⁽¹⁾		40	А
E _{AS}	Single Pulsed Avalanche Energy ⁽²⁾		12	mJ
P _D	Power Dissipation	T _C = 25°C	26.6	W
$R_{ ext{ hetaJC}}$	Thermal Resistance, Junction to Case		4.7	°C/W
T _J , T _{stg}	Junction & Storage Temperature Range		-55 to 150	°C



Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_{D} = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
V _{GS(th)}	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	1	2	2.5	V
_	(3)	V _{GS} = 10V, I _D = 5A	-	120	156	mΩ
$R_{DS(ON)}$	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 4.5V, I _D = 3A	-	126	164	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-	655	-	pF
C _{oss}	Output Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1MHz	Χ-	31	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1101112		24	-	pF
Q _g	Total Gate Charge	0	<u> </u>	14.8	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0$ to 10V $V_{DS} = 50V$, $I_D = 3A$) -	3	-	nC
Q_{gd}	Gate Drain("Miller") Charge	$v_{\rm DS} = 30 v$, $i_{\rm D} = 3A$	-	4.4	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	12	-	ns
t _r	Turn-On Rise Time	V _{GS} = 10V, V _{DD} = 50V	-	7.6	-	ns
$t_{d(off)}$	Turn-Off DelayTime	I_D = 3A, R_{GEN} = 3 Ω	-	36	-	ns
t _f	Turn-Off Fall Time		-	9.2	-	ns
Drain-So	urce Diode Characteristics and I	Max Ratings				
I _S	Maximum Continuous Drain to Source D	iode Forward Current	-	-	10	А
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	40	А
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 10A	-	-	1.2	V
Notes:	1. Repetitive Rating: Pulse Width Limited by Maxin	num Junction Temperature.				

2. E_{AS} condition: Starting T_J=25°C, V_{DD}=50V, V_G=10V, R_G=250hm, L=0.5mH, I_{AS}=7A

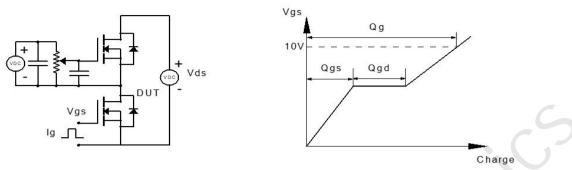
3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

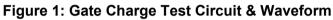


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Test Circuit





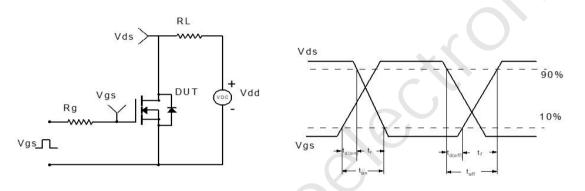
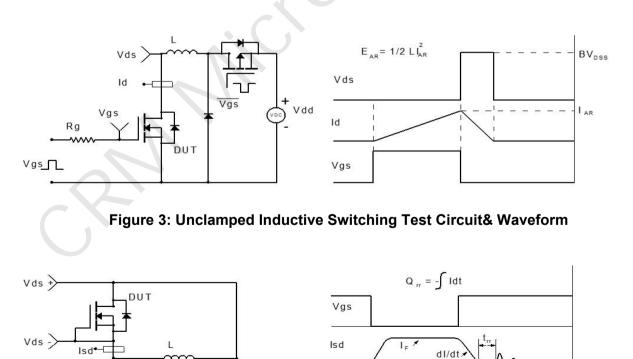


Figure 2: Resistive Switching Test Circuit & Waveform





↓+ voc Vdd

Ig

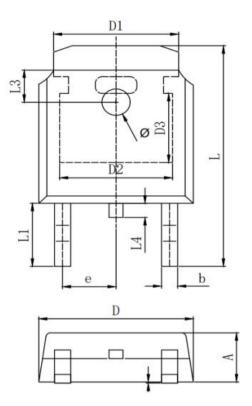
Vdd

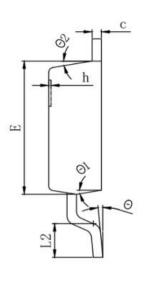
I_BA

Vds



Package Mechanical Data(TO-252-3L)





SYMBOL	MILLIMETER				
SIMBOL	MIN	Typ.	MAX		
A	2.200	2.300	2.400		
Al	0.000		0.127		
b	0.640	0.690	0.740		
c(电镀后)	0.460	0.520	0.580		
D	6.500	6.600	6.700		
D1	5.334 REF				
D2	4.826 REF				
D3	3.166 REF				
E	6.000	6.100	6.200		
е	2. 286 TYP				
h	0.000	0.100	0.200		
L	9.900	10.100	10.300		
L1	2.888 REF				
L2	1.400	1.550	1.700		
L3	1.600 REF				
L4	0.600	0.800	1.000		
ф	1.100	1.200	1.300		
θ	0°		8°		
θ1	9° TYP				
02	9° TYP				

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Contact information

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